



Multilayer Diplexer

For LTE//n77

DPX Series 1.6x0.8mm [EIA 0603] TYPE

P/N: **DPX164200DT-8202B1**

0

(1)

۵

b

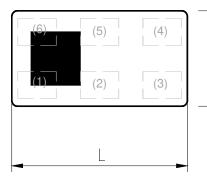
 \geq

May. 2021 Ver.2.0 TDK Corporation

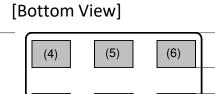
DPX164200DT-8202B1

SHAPES AND DIMENSIONS

[Top View]

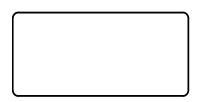






(2)

(3)



Dimensions (mm)

L	W	T	а	b	С	d
1.60	0.80	0.65	0.35	0.22	0.225	0.22
+/-0.10	+/-0.10	Max	+/-0.05	+/-0.05	+/-0.05	+/-0.05

Terminal functions

(1)	GND	(4)	High-Band Port
(2)	Common Port	(5)	GND
(3)	GND	(6)	Low-Band Port

TERMINATION FINISH

Material	
Ag	

(Measurement)

DPX164200DT-8202B1

ELECTRICAL CHARACTERISTICS

Low-Band

Parameter	Freque	nov	(MH7)	T	OK Sp	ec
Farameter	rieque	псу	(101112)	Min.	Тур.	Max.
Insertion Loss (dB)	617	to	960	-	0.11	0.50
	1166	to	1606	-	0.26	0.50
	1710	to	1785	-	0.31	0.50
	1805	to	1885	-	0.34	0.50
	1930	to	1990	-	0.37	0.50
	2300	to	2496	-	0.54	0.90
	2496	to	2690	-	0.68	1.10
Insertion Loss (dB)	617	to	960	-	-	0.70
(–40 to +85 °C)	1166	to	1606	-	-	0.70
	1710	to	1785	-	-	0.70
	1805	to	1885	-	-	0.70
	1930	to	1990	-	-	0.70
	2300	to	2496	-	-	1.10
	2496	to	2690	-	-	1.30
Return Loss@Low-Band (dB)	617	to	2690	10	15	-
Attenuation (dB)	3300	to	3700	15	20	-
	3700	to	3800	15	22	-
	3800	to	4200	20	23	-
	4400	to	5000	25	30	-
	5150	to	5925	20	25	-
	5925	to	12750	10	21	-
Characteristic Impedance (ohm)				50	(Nomiı	nal)

Ta = +25+/-5°C

公TDK

DPX164200DT-8202B1

ELECTRICAL CHARACTERISTICS

High-Band

Parameter	Freque	nov		TI	DK Sp	ec
Farameter	Freque	псу		Min.	Тур.	Max.
Insertion Loss (dB)	3300	to	4200	-	0.91	1.24
Insertion Loss (dB)	3300	to	4200	-	-	1.50
(–40 to +85 °C)						
Return Loss@High-Band (dB)	3300	to	4200	10	18	-
Attenuation (dB)	500	to	1606	13	15	-
	1606	to	2400	13	14	-
	2400	to	2500	14	17	-
	2500	to	2690	15	18	-
	2700	to	3150	0.5	2.2	-
	4400	to	4900	0.5	1.1	-
	4900	to	5150	5	8.5	-
	5150	to	5925	10	13	-
	6250	to	6550	10	12	-
	6600	to	8400	10	12	-
	8400	to	9000	15	22	-
	9900	to	12660	10	12	-
	13200	to	16800	3	7	-
Characteristic Impedance (ohm)				50	(Nomi	nal)

 $Ta = +25 + / -5^{\circ}C$

Common

Parameter	Eroquo	nov		T	OK Sp	ec
Farameter	Freque	псу		Min.	Тур.	Max.
Return Loss (dB)	617	to	2690	10	17.0	-
(Common Port)	3300	to	4200	10	17.0	-
Characteristic Impedance (ohm)				50	(Nomii	nal)

 $Ta = +25 + / -5^{\circ}C$

(Measurement)

Isolation

⊘TDK

DPX164200DT-8202B1

ELECTRICAL CHARACTERISTICS

(Measurement)

Parameter	Froquo	nov		T	OK Sp	ec
Farameter	Freque	псу		Min.	Тур.	Max.
Isolation (dB)	617	to	2690	13	15	-
	3300	to	4200	18	23	-

Ta = +25+/-5°C

MAXIMUM RATINGS

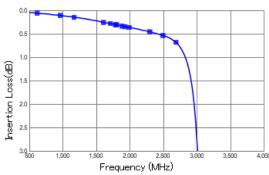
Parameter				TDK Spec	Conditions
Operating temperature (°C)				–40 to +85 °C	
Storage temperature (°C)				–40 to +85 °C	
Power Handling (W) *1	Freque	ncy	(MHz)		
Low-Band	698	to	960	4	GSM signal Duty 50%
	1427	to	2690	1	CW
High-Band	3300	to	4200	1	CW
Human Body Model : HBM	@Ea	ch P	ort (V)	+/-1000	100pF / 1500ohm
Machine Model : MM	@Each Port (V)		+/-150	200pF / 0ohm	
Charged Device Model : CDM	@Ea	ch P	ort (V)	+/-500	Humidity : 60%RH max

*1 : Refer to 3GPP TS 38.101-1 V15.2.0

DPX164200DT-8202B1

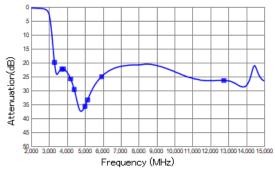
FREQUENCY CHARACTERISTICS

Insertion Loss (Low-Band)



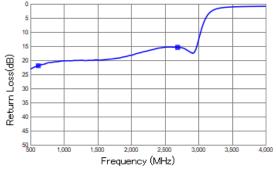
	Freq	dB	Freq	dB
	617	0.06	1885	0.34
	960	0.11	1930	0.35
	1166	0.15	1990	0.37
	1606	0.26	2300	0.46
	1710	0.28	2496	0.54
	1785	0.31	2690	0.68
	1805	0.31		
00				

Attenuation (Low-Band)



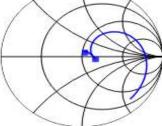
Freq	dB
3300	19.9
3700	22.3
3800	22.3
4200	25.8
4400	29.6
5000	35.7
5150	33.4
5925	25.0
12750	26.4

Return Loss (Low-Band)



Freq dB 617 21.9 2690

15.5



Smith Chart (Low-Band)

Freq	r/x
617	52.68/7.8
2690	69.78/-4.32

All specifications are subject to change without notice. TDK Technology - Proprietary and Confidential Information of TDK Group Companies

DPX164200DT-8202B1

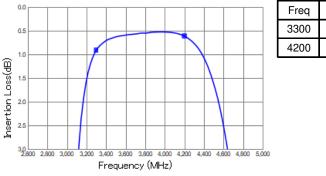
FREQUENCY CHARACTERISTICS

dB

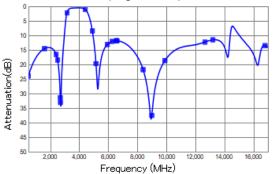
0.91

0.61

Insertion Loss (High-Band)

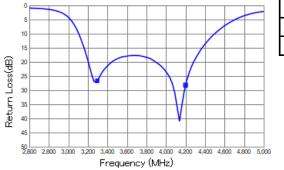


Attenuation (High-Band)

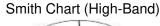


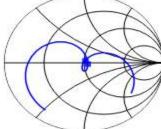
	Freq	dB	Freq	dB	Freq	dB
	500	24.0	4400	1.07	8400	21.8
	1606	14.6	4900	8.47	9000	37.5
	2400	16.6	5150	19.7	9900	18.7
	2500	18.5	5925	13.2	12660	12.3
_	2690	31.4	6250	12.1	13200	11.5
-	2700	33.1	6550	11.9	16800	13.5
	3150	2.24	6600	11.9		

Return Loss (High-Band)



Freq	dB
3300	26.6
4200	28.2





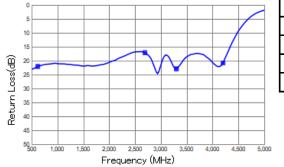
Freq	r/x
3300	54.65/-1.53
4200	51.12/3.76

DPX164200DT-8202B1

FREQUENCY CHARACTERISTICS

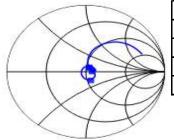
Isolation Freq dB 5 22.4 617 10 24.8 2690 15 20 25 Isolation(dB) 3300 25.9 4200 25.4 30 35 40 45 50 18,000 2,000 14,000 16,000 Frequency (MHz)

Return Loss (Common)



Freq	dB
617	22.1
2690	17.2
3300	22.9
4200	20.8

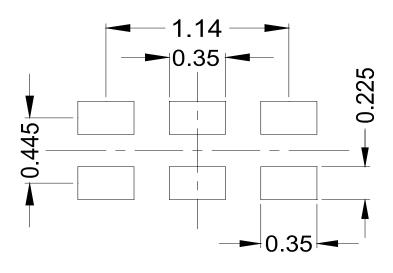
Smith Chart (Common)



Freq	r/x
617	53.07/7.53
2690	54.41/-13.94
3300	57.57/1.3
4200	53.63/8.74

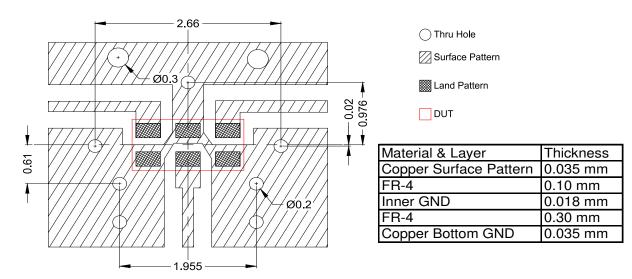
DPX164200DT-8202B1

RECOMMENDED LAND PATTERN



unit : mm

EVALUATION BOARD



- * Line width should be designed to match 50 ohm characteristic impedance depending on PCB material and thickness.
- ** The position of the throuh hole which have possibility of influence to the prerformance are indicated by dimension line.

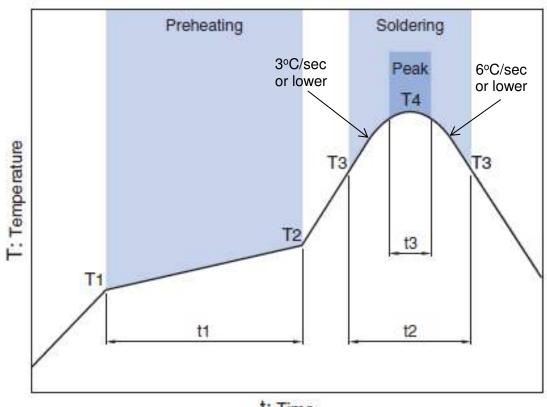
ENVIRONMENT INFORMATION

RoHS Statement RoHS Compliance

> All specifications are subject to change without notice. TDK Technology - Proprietary and Confidential Information of TDK Group Companies

DPX164200DT-8202B1

RECOMMENDED REFLOW PROFILE



÷	
T	LIDD O
۰.	Time

Preheating		Soldering				
Freneating			Critical zon	e (T3 to T4)	Peak	
Tei	Temp. Time		Temp. Time		Temp. Time	
T1	T2	t1	Т3	t2	T4	t3 *
150°C	200°C	60 to 120sec	217°C	60 to 120sec	240 to 260°C	30 sec Max

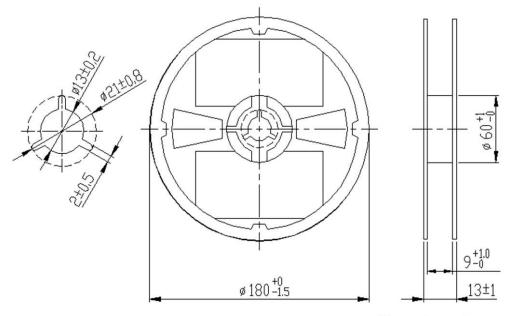
* t3 : Time within 5°C of actual peak temperature The maximum number of reflow is 3.

Note: Lead free solder is recommended. Recommended solder is Sn-3.0Ag-0.5Cu. (M705 by Senju Metal Industry)

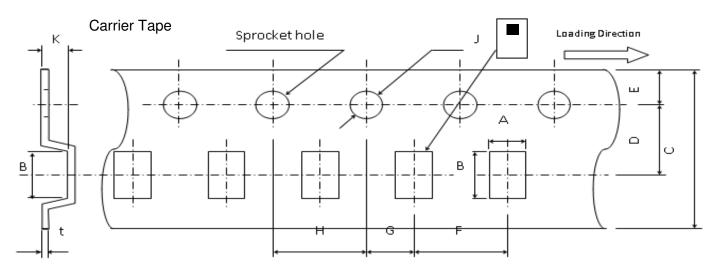
DPX164200DT-8202B1

PACKAGING STYLE

Reel Dimensions



Dimensions in mm



Dimensions (mm)

Α	В	С	D	Ε	F	G	Н	J	Κ	t
0.97	1.8	8.0	3.5	1.75	4.0	2.0	4.0	1.5	0.8	0.25
+/-0.05	+/-0.05	+/-0.2	+/-0.05	+/-0.1	+/-0.1	+/-0.05	+/-0.1	+0.1/-0	MAX	+/-0.05

STANDARD PACKAGE QUANTITY (pieces/reel) 4,000

REMINDERS FOR USING THESE PRODUCTS

Before using these products, be sure to request the delivery specifications.

SAFETY REMINDERS

Please pay sufficient attention to the warnings for safe designing when using these products.

The products listed on this specification sheet are intended for use in general electronic equipment (AV equipment, telecommunications equipment, home appliances, amusement equipment, computer equipment, personal equipment, office equipment, measurement equipment, industrial robots) under a normal operation and use condition.

The products are not designed or warranted to meet the requirements of the applications listed below, whose performance and/or quality require a more stringent level of safety or reliability, or whose failure, malfunction or trouble could cause serious damage to society, person or property. Please understand that we are not responsible for any damage or liability caused by use of the products in any of the applications below or for any other use exceeding the range or conditions set forth in this specification sheet.

- 1. Aerospace/Aviation equipment
- 2. Transportation equipment (cars, electric trains, ships, etc.)
- 3. Medical equipment
- 4. Power-generation control equipment
- 5. Atomic energy-related equipment
- 6. Seabed equipment
- 7. Transportation control equipment
- 8. Public information-processing equipment
- 9. Military equipment
- 10. Electric heating apparatus, burning equipment
- 11. Disaster prevention/crime prevention equipment
- 12. Safety equipment
- 13. Other applications that are not considered general-purpose applications

When using this product in general-purpose applications, you are kindly requested to take into consideration securing protection circuit/equipment or providing backup circuits, etc., to ensure higher safety.